

LM123/LM323A/LM323-N 3-Amp, 5-Volt Positive Regulator

Check for Samples: LM123, LM323-N, LM323A

FEATURES

- Ensured 1% Initial Accuracy (A Version)
- 3 Amp Output Current
- Internal Current and Thermal Limiting
- 0.01Ω Typical Output Impedance
- 7.5V Minimum Input Voltage
- 30W Power Dissipation
- P⁺ Product Enhancement tested

DESCRIPTION

The LM123 is a three-terminal positive regulator with a preset 5V output and a load driving capability of 3 amps. New circuit design and processing techniques are used to provide the high output current without sacrificing the regulation characteristics of lower current devices.

The LM323A offers improved precision over the standard LM323-N. Parameters with tightened specifications include output voltage tolerance, line regulation, and load regulation.

The 3 amp regulator is virtually blowout proof. Current limiting, power limiting, and thermal shutdown provide the same high level of reliability obtained with these techniques in the LM109 1 amp regulator.

No external components are required for operation of the LM123. If the device is more than 4 inches from the filter capacitor, however, a 1 μ F solid tantalum capacitor should be used on the input. A 0.1 μ F or larger capacitor may be used on the output to reduce load transient spikes created by fast switching digital logic, or to swamp out stray load capacitance.

An overall worst case specification for the combined effects of input voltage, load currents, ambient temperature, and power dissipation ensure that the LM123 will perform satisfactorily as a system element.

For applications requiring other voltages, see LM150 series adjustable regulator data sheet.

Operation is specified over the junction temperature range -55°C to +150°C for LM123, -40°C to +125°C for LM323A, and 0°C to +125°C for LM323-N. A hermetic TO-3 package is used for high reliability and low thermal resistance.

Connection Diagram

Metal Can Package

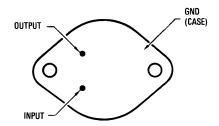


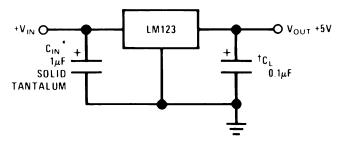
Figure 1. See Package Number NDS

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Typical Applications



^{*}Required if LM123 is more than 4" from filter capacitor.

Figure 2. Basic 3 Amp Regulator

[†]Regulator is stable with no load capacitor into resistive loads.





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings (1) (2)(3)

Input Voltage	20V	
Power Dissipation	Internally Limited	
Operating Junction Temperature Range	LM123	−55°C to +150°C
	LM323A	−40°C to +125°C
	LM323-N	0°C to +125°C
Storage Temperature Range	−65°C to +150°C	
Lead Temperature (Soldering, 10 sec.)	300°C	
ESD Tolerance ⁽⁴⁾	2000V	

^{(1) &}quot;Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits.

- (2) Refer to RETS123K drawing for LM123K military specifications.
- (3) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (4) Human body model, $1.5 \text{ k}\Omega$ in series with 100 pF.

LM123 Electrical Characteristics⁽¹⁾

Parameter	C	onditions		Units			
		Min			Max		
Output Voltage	$T_{j} = 25^{\circ}C$ $V_{IN} = 7.5V, I_{OL}$	_{JT} = 0A	4.7	5	5.3	V	
	$7.5V \le V_{IN} \le 18$ $0A \le I_{OUT} \le 3A$		4.6		5.4	V	
Line Regulation (2)	$T_j = 25^{\circ}C$ 7.5V $\leq V_{IN} \leq 18$	5V		5	25	mV	
Load Regulation (2)	$T_j = 25^{\circ}C, V_{IN}$ $0A \le I_{OUT} \le 3A$			25	100	mV	
Quiescent Current	$7.5V \le V_{IN} \le 18$ $0A \le I_{OUT} \le 3A$			12	20	mA	
Output Noise Voltage	$T_j = 25^{\circ}C$ 10 Hz \le f \le 10	0 kHz		40		μVrms	
Short Circuit Current Limit	T _j = 25°C	V _{IN} = 15V		3	4.5	А	
		V _{IN} = 7.5V		4	5	А	
Long Term Stability					35	mV	
Thermal Resistance Junction to Case (3)				2		°C/W	

⁽¹⁾ Unless otherwise noted, specifications apply for -55°C ≤ T_j ≤ +150°C for the LM123, -40°C ≤ T_j ≤ +125°C for the LM323A, and 0°C ≤ T_j ≤ +125°C for the LM323-N. Although power dissipation is internally limited, specifications apply only for P ≤ 30W.

Product Folder Links: LM123 LM323-N LM323A

⁽²⁾ Load and line regulation are specified at constant junction temperature. Pulse testing is required with a pulse width ≤ 1 ms and a duty cycle ≤ 5%.

⁽³⁾ Without a heat sink, the thermal resistance of the TO-3 package is about 35°C/W. With a heat sink, the effective thermal resistance can only approach the specified values of 2°C/W, depending on the efficiency of the heat sink.



LM323A/LM323-N Electrical Characteristics (1)

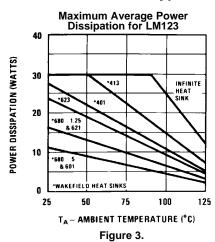
Parameter	Conditions		LM323A			LM323-N			Units
			Min	Тур	Max	Min	Тур	Max	
Output Voltage	$T_j = 25^{\circ}C$ $V_{IN} = 7.5V, I_0$	4.95	5	5.05	4.8	5	5.2	V	
	$7.5V \le V_{IN} \le 0A \le I_{OUT} \le 3$		4.85		5.15	4.75		5.25	V
Line Regulation ⁽²⁾	$T_j = 25$ °C 7.5V \leq V _{IN} \leq	15V		5	10		5	25	mV
Load Regulation ⁽²⁾	$T_j = 25$ °C, V_l $0A \le I_{OUT} \le 3$			25	50		25	100	mV
Quiescent Current	7.5V ≤ V _{IN} ≤ 0A ≤ I _{OUT} ≤ 3			12	20		12	20	mA
Output Noise Voltage	$T_j = 25^{\circ}C$ 10 Hz \le f \le 1	$T_j = 25^{\circ}C$ 10 Hz \le f \le 100 kHz					40		μVrms
Short Circuit Current Limit	T _j = 25°C	V _{IN} = 15V		3	4.5		3	4.5	Α
		$V_{IN} = 7.5V$		4	6		4	5	Α
Long Term Stability					35			35	mV
Thermal Resistance Junction to Case ⁽³⁾				2			2		°C/W

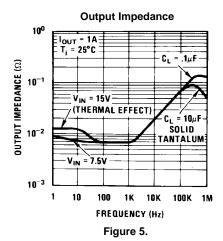
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(2) Load and line regulation are specified at constant junction temperature. Pulse testing is required with a pulse width ≤ 1 ms and a duty

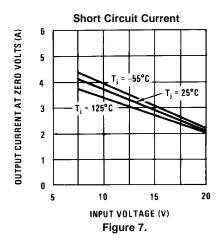
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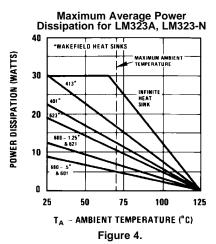


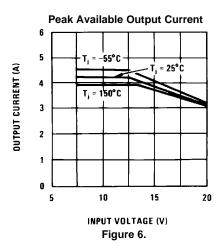
Typical Performance Characteristics

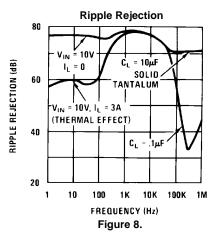






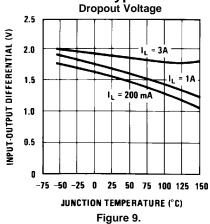


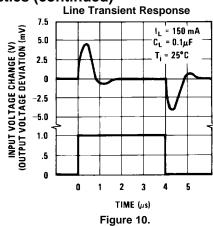


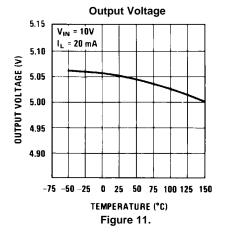


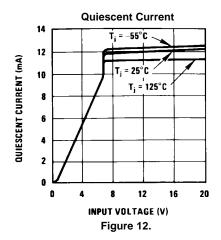


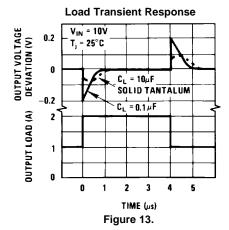
Typical Performance Characteristics (continued)

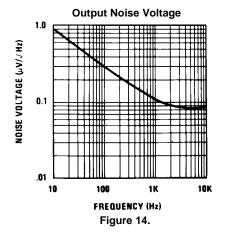






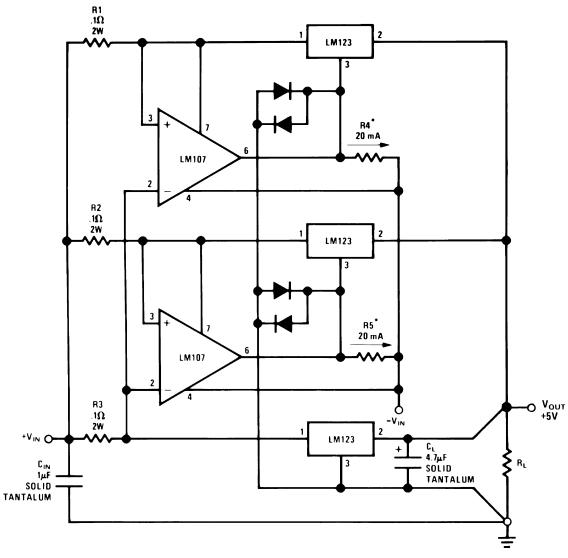








TYPICAL APPLICATIONS



*Select for 20 mA Current from Unregulated Negative Supply

Figure 15. 10 Amp Regulator with Complete Overload Protection



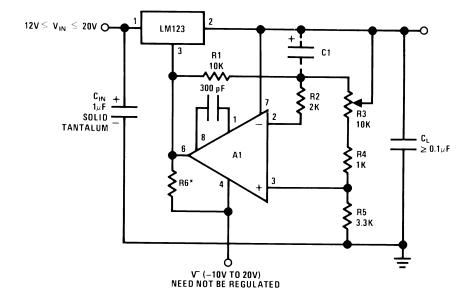


Figure 16. Adjustable Regulator 0V-10V @ 3A

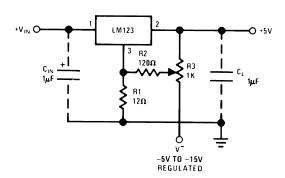
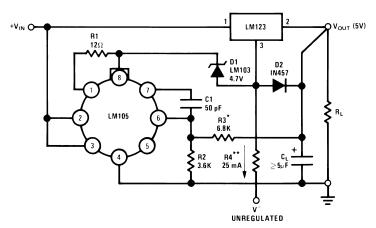


Figure 17. Trimming Output to 5V



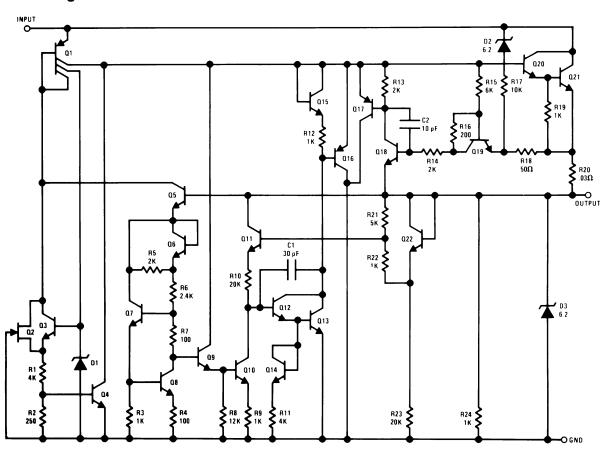
^{*}Select to Set Output Voltage

Figure 18. Adjustable Output 5V-10V 0.1% Regulation

^{**}Select to Draw 25 mA from V



Schematic Diagram





PACKAGE OPTION ADDENDUM

11-Apr-2013

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
LM323K STEEL	ACTIVE	TO-3	NDS	2	50	TBD	Call TI	Call TI	0 to 125	LM323K STEEL	Samples
LM323K STEEL/NOPB	ACTIVE	TO-3	NDS	2	50	Green (RoHS & no Sb/Br)	POST-PLATE	Level-1-NA-UNLIM	0 to 125	LM323K STEEL	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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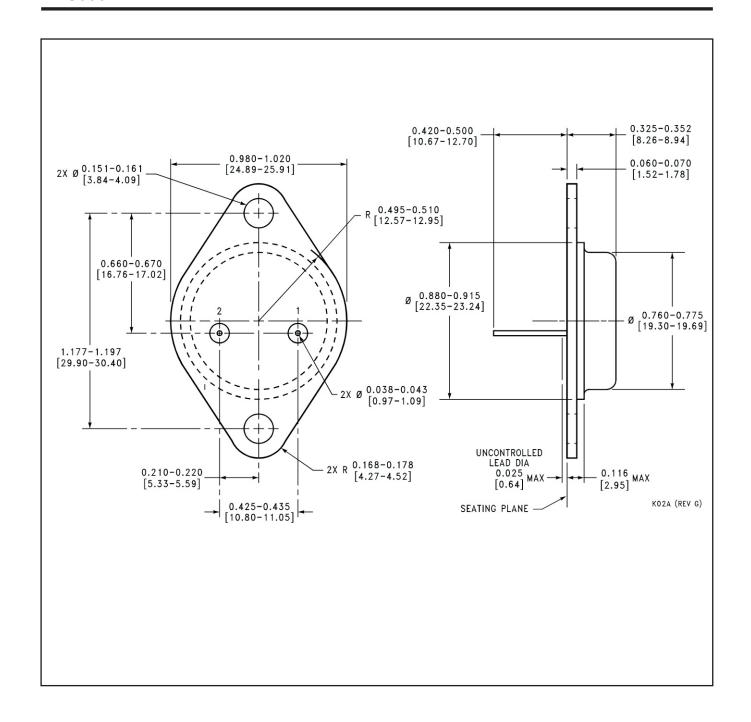
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.



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